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ALPHA & OMEGA
 SEMICONDUCTOR

AOT7S60/AOB7S60/AOTF7S60 600V 7A α MOS™ Power Transistor

General Description

The AOT7S60 & AOB7S60 & AOTF7S60 have been fabricated using the advanced α MOS™ high voltage process that is designed to deliver high levels of performance and robustness in switching applications. By providing low $R_{DS(on)}$, Q_g and E_{oss} along with guaranteed avalanche capability these parts can be adopted quickly into new and existing offline power supply designs.

For Halogen Free add "L" suffix to part number:
 AOT7S60L & AOB7S60L & AOTF7S60L

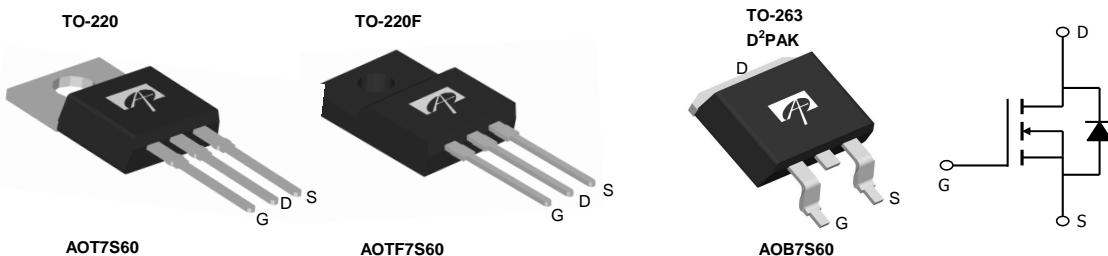
Product Summary

V_{DS} @ $T_{j,max}$	700V
I_{DM}	33A
$R_{DS(ON),max}$	0.6Ω
$Q_{g,typ}$	8.2nC
E_{oss} @ 400V	1.9μJ

100% UIS Tested
 100% R_g Tested



Top View



Absolute Maximum Ratings $T_A=25^\circ\text{C}$ unless otherwise noted

Parameter	Symbol	AOT7S60/AOB7S60	AOTF7S60L	Units
Drain-Source Voltage	V_{DS}	600		V
Gate-Source Voltage	V_{GS}	± 30		V
Continuous Drain Current ^A	I_D $T_c=25^\circ\text{C}$	7	7*	A
Current ^A	$T_c=100^\circ\text{C}$	5	5*	
Pulsed Drain Current ^C	I_{DM}	33		
Avalanche Current ^C	I_{AR}	1.7		A
Repetitive avalanche energy ^C	E_{AR}	43		mJ
Single pulsed avalanche energy ^G	E_{AS}	86		mJ
Power Dissipation ^B	P_D $T_c=25^\circ\text{C}$	104	34	W
	Derate above 25°C	0.8	0.3	W/ °C
MOSFET dv/dt ruggedness	dv/dt	100		V/ns
Peak diode recovery dv/dt ^H		20		
Junction and Storage Temperature Range	T_J, T_{STG}	-55 to 150		°C
Maximum lead temperature for soldering purpose, 1/8" from case for 5 seconds ^J	T_L	300		°C
Thermal Characteristics				
Parameter	Symbol	AOT7S60/AOB7S60	AOTF7S60L	Units
Maximum Junction-to-Ambient ^{A,D}	$R_{\theta JA}$	65	65	°C/W
Maximum Case-to-sink ^A	$R_{\theta CS}$	0.5	--	°C/W
Maximum Junction-to-Case	$R_{\theta JC}$	1.2	5	°C/W

* Drain current limited by maximum junction temperature.



AOT7S60/AOB7S60/AOTF7S60

Electrical Characteristics ($T_J=25^\circ\text{C}$ unless otherwise noted)

Symbol	Parameter	Conditions	Min	Typ	Max	Units
STATIC PARAMETERS						
BV_{DSS}	Drain-Source Breakdown Voltage	$I_D=250\mu\text{A}, V_{GS}=0\text{V}, T_J=25^\circ\text{C}$	600	-	-	V
		$I_D=250\mu\text{A}, V_{GS}=0\text{V}, T_J=150^\circ\text{C}$	650	700	-	
I_{DSS}	Zero Gate Voltage Drain Current	$V_{DS}=600\text{V}, V_{GS}=0\text{V}$	-	-	1	μA
		$V_{DS}=480\text{V}, T_J=150^\circ\text{C}$	-	10	-	
I_{GSS}	Gate-Body leakage current	$V_{DS}=0\text{V}, V_{GS}=\pm 30\text{V}$	-	-	± 100	nA
$V_{\text{GS}(\text{th})}$	Gate Threshold Voltage	$V_{DS}=5\text{V}, I_D=250\mu\text{A}$	2.7	3.3	3.9	V
$R_{\text{DS(ON)}}$	Static Drain-Source On-Resistance	$V_{GS}=10\text{V}, I_D=3.5\text{A}, T_J=25^\circ\text{C}$	-	0.54	0.60	Ω
		$V_{GS}=10\text{V}, I_D=3.5\text{A}, T_J=150^\circ\text{C}$	-	1.48	1.64	Ω
V_{SD}	Diode Forward Voltage	$I_S=3.5\text{A}, V_{GS}=0\text{V}, T_J=25^\circ\text{C}$	-	0.82	1.2	V
I_S	Maximum Body-Diode Continuous Current		-	-	7	A
I_{SM}	Maximum Body-Diode Pulsed Current ^C		-	-	33	A
DYNAMIC PARAMETERS						
C_{iss}	Input Capacitance	$V_{GS}=0\text{V}, V_{DS}=100\text{V}, f=1\text{MHz}$	-	372	-	pF
C_{oss}	Output Capacitance		-	28	-	pF
$C_{\text{o(er)}}$	Effective output capacitance, energy related ^H	$V_{GS}=0\text{V}, V_{DS}=0 \text{ to } 480\text{V}, f=1\text{MHz}$	-	22	-	pF
$C_{\text{o(tr)}}$	Effective output capacitance, time related ^I		-	65	-	pF
C_{rss}	Reverse Transfer Capacitance	$V_{GS}=0\text{V}, V_{DS}=100\text{V}, f=1\text{MHz}$	-	1.2	-	pF
R_g	Gate resistance	$V_{GS}=0\text{V}, V_{DS}=0\text{V}, f=1\text{MHz}$	-	17.5	-	Ω
SWITCHING PARAMETERS						
Q_g	Total Gate Charge	$V_{GS}=10\text{V}, V_{DS}=480\text{V}, I_D=3.5\text{A}$	-	8.2	-	nC
Q_{gs}	Gate Source Charge		-	2.0	-	nC
Q_{gd}	Gate Drain Charge		-	2.8	-	nC
$t_{\text{D(on)}}$	Turn-On Delay Time	$V_{GS}=10\text{V}, V_{DS}=400\text{V}, I_D=3.5\text{A}, R_G=25\Omega$	-	19	-	ns
t_r	Turn-On Rise Time		-	13	-	ns
$t_{\text{D(off)}}$	Turn-Off Delay Time		-	50	-	ns
t_f	Turn-Off Fall Time		-	15	-	ns
t_{rr}	Body Diode Reverse Recovery Time	$I_F=3.5\text{A}, dI/dt=100\text{A}/\mu\text{s}, V_{DS}=400\text{V}$	-	198	-	ns
I_{rm}	Peak Reverse Recovery Current	$I_F=3.5\text{A}, dI/dt=100\text{A}/\mu\text{s}, V_{DS}=400\text{V}$	-	18	-	A
Q_{rr}	Body Diode Reverse Recovery Charge	$I_F=3.5\text{A}, dI/dt=100\text{A}/\mu\text{s}, V_{DS}=400\text{V}$	-	2.4	-	μC

A. The value of R_{JJA} is measured with the device in a still air environment with $T_A=25^\circ\text{C}$.

B. The power dissipation P_D is based on $T_{J(\text{MAX})}=150^\circ\text{C}$, using junction-to-case thermal resistance, and is more useful in setting the upper dissipation limit for cases where additional heatsinking is used.

C. Repetitive rating, pulse width limited by junction temperature $T_{J(\text{MAX})}=150^\circ\text{C}$, Ratings are based on low frequency and duty cycles to keep initial $T_J=25^\circ\text{C}$.

D. The R_{JJA} is the sum of the thermal impedance from junction to case R_{JJC} and case to ambient.

E. The static characteristics in Figures 1 to 6 are obtained using $<300\ \mu\text{s}$ pulses, duty cycle 0.5% max.

F. These curves are based on the junction-to-case thermal impedance which is measured with the device mounted to a large heatsink, assuming a maximum junction temperature of $T_{J(\text{MAX})}=150^\circ\text{C}$. The SOA curve provides a single pulse rating.

G. $L=60\text{mH}, I_{AS}=1.7\text{A}, V_{DD}=150\text{V}$, Starting $T_J=25^\circ\text{C}$

H. $C_{\text{o(er)}}$ is a fixed capacitance that gives the same stored energy as C_{oss} while V_{DS} is rising from 0 to 80% $V_{(\text{BR})\text{DSS}}$.

I. $C_{\text{o(tr)}}$ is a fixed capacitance that gives the same charging time as C_{oss} while V_{DS} is rising from 0 to 80% $V_{(\text{BR})\text{DSS}}$.

J. Wavesoldering only allowed at leads.

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AOT7S60/AOB7S60/AOTF7S60

TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS

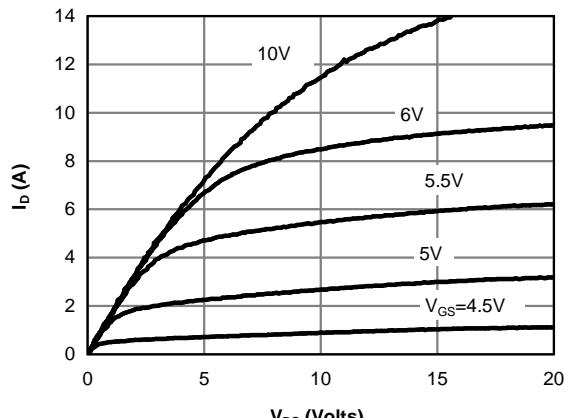


Figure 1: On-Region Characteristics@25°C

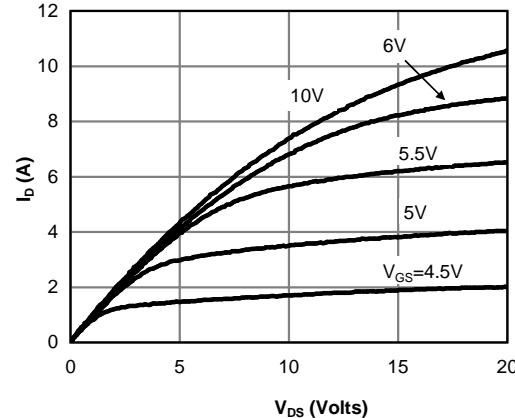


Figure 2: On-Region Characteristics@125°C

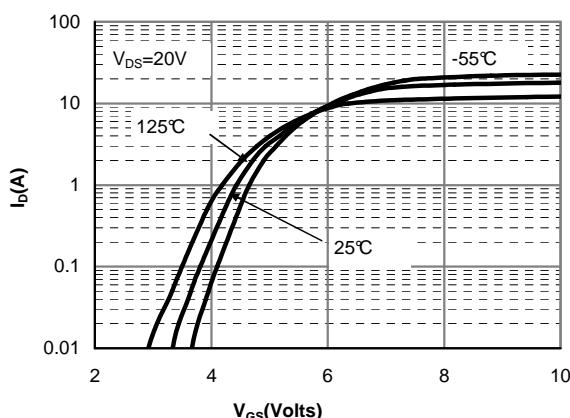


Figure 3: Transfer Characteristics

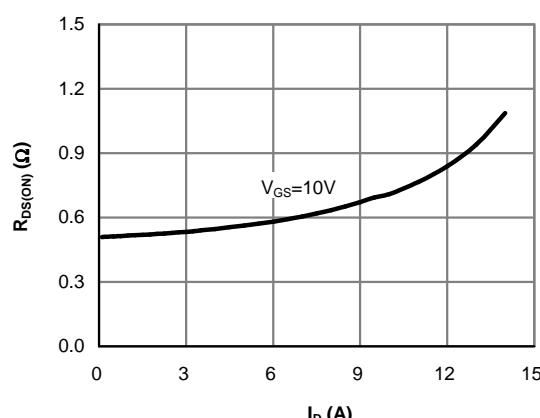


Figure 4: On-Resistance vs. Drain Current and Gate Voltage

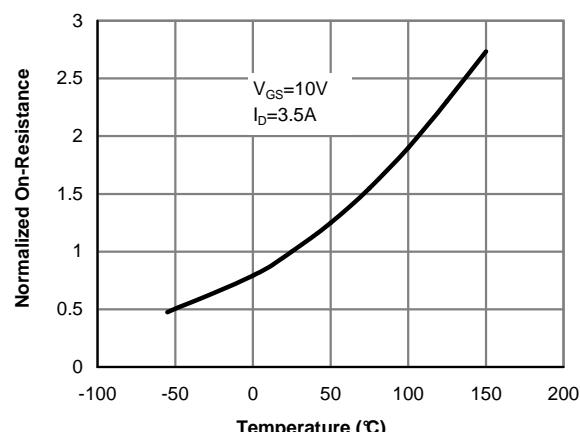


Figure 5: On-Resistance vs. Junction Temperature

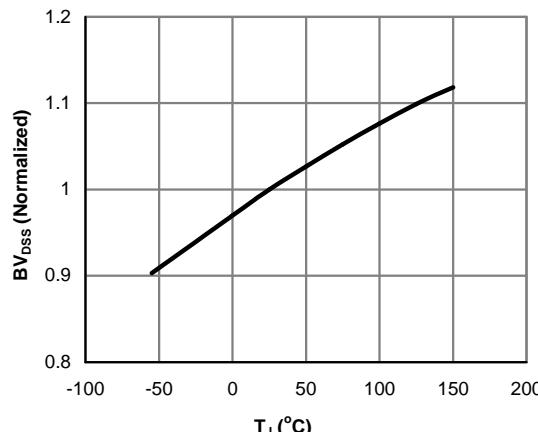


Figure 6: Break Down vs. Junction Temperature



AOT7S60/AOB7S60/AOTF7S60

TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS

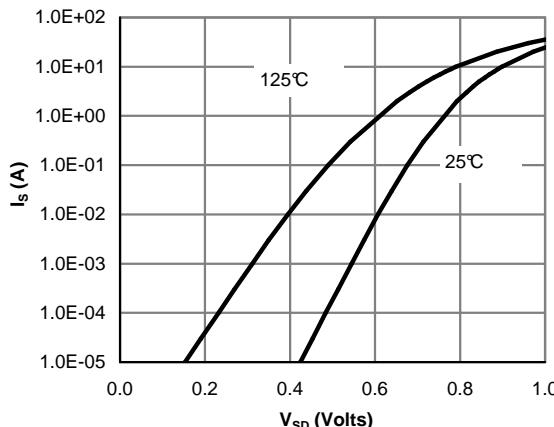


Figure 7: Body-Diode Characteristics (Note E)

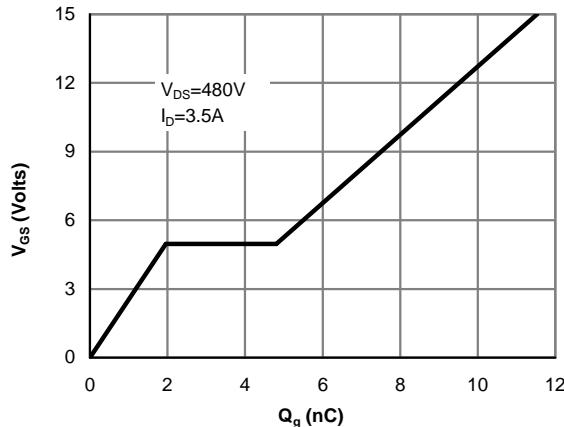


Figure 8: Gate-Charge Characteristics

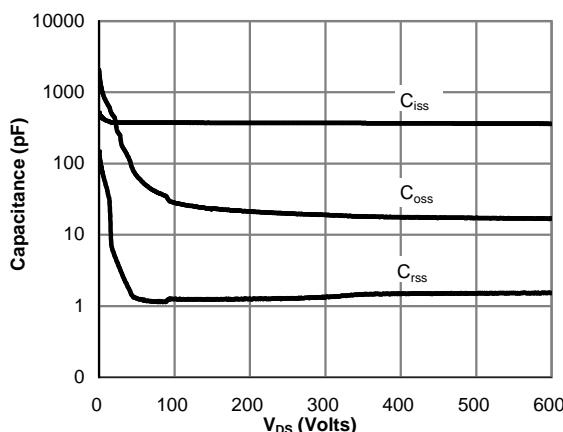


Figure 9: Capacitance Characteristics

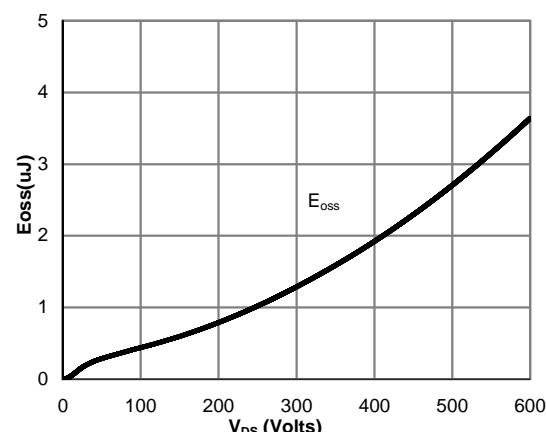


Figure 10: Coss stroed Energy

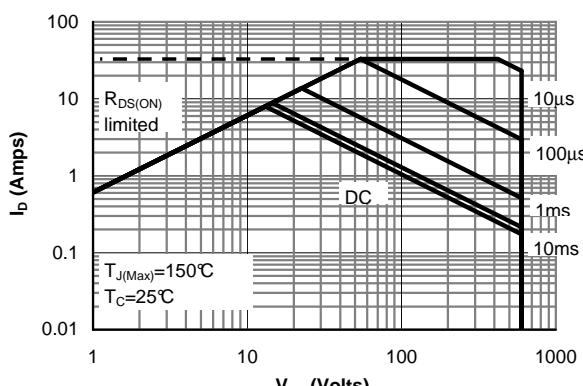


Figure 11: Maximum Forward Biased Safe Operating Area for AOT(B)7S60 (Note F)

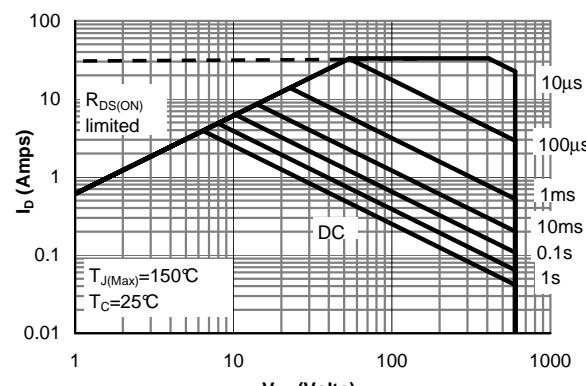


Figure 12: Maximum Forward Biased Safe Operating Area for AOTF7S60L (Note F)



AOT7S60/AOB7S60/AOTF7S60

TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS

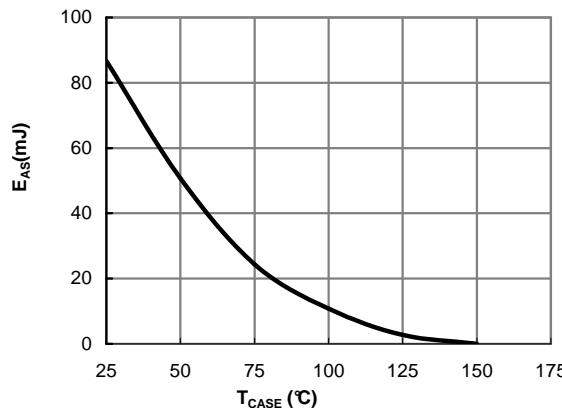


Figure 13: Avalanche energy

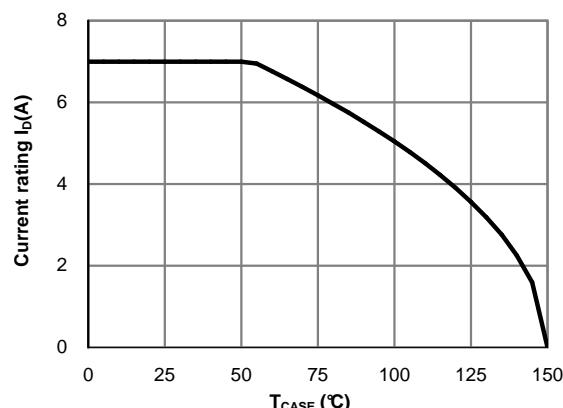


Figure 14: Current De-rating (Note B)

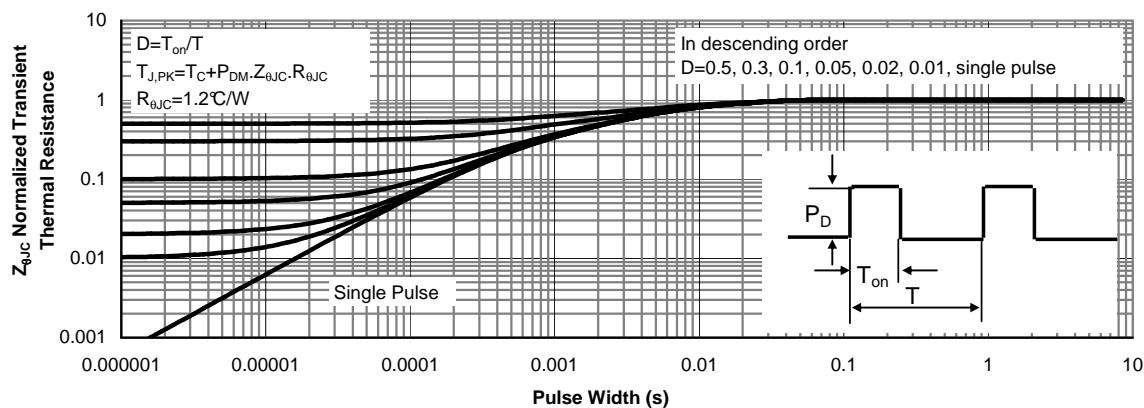


Figure 15: Normalized Maximum Transient Thermal Impedance for AOT(B)7S60 (Note F)

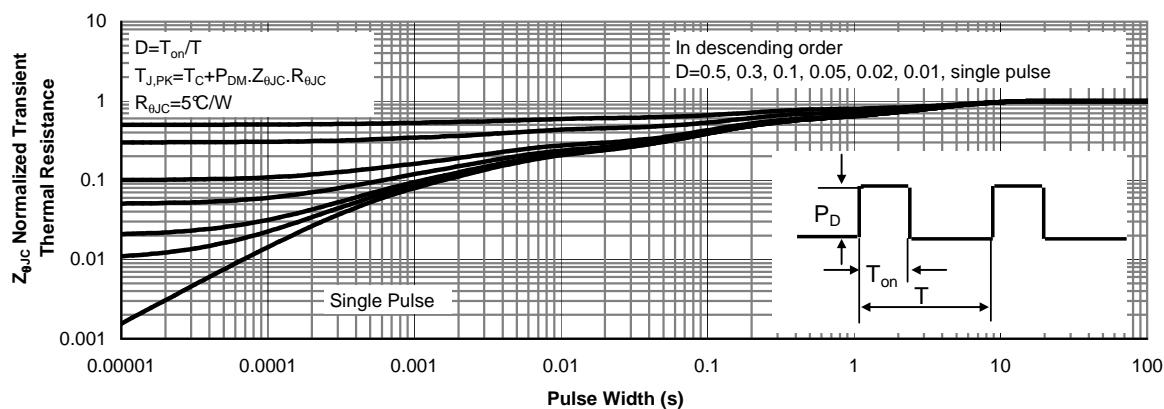
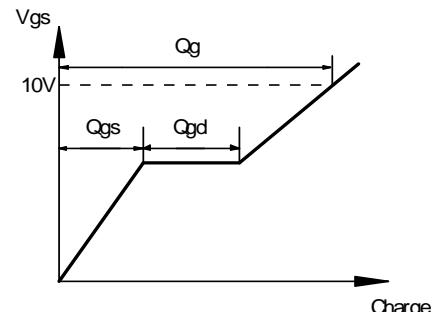
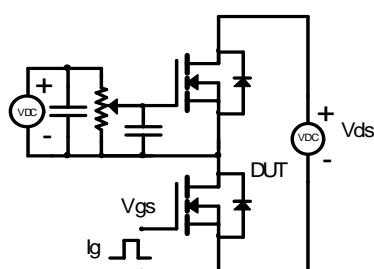


Figure 16: Normalized Maximum Transient Thermal Impedance for AOTF7S60L (Note F)

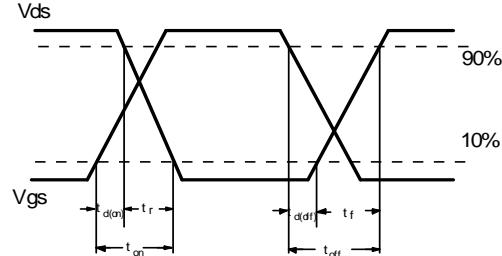
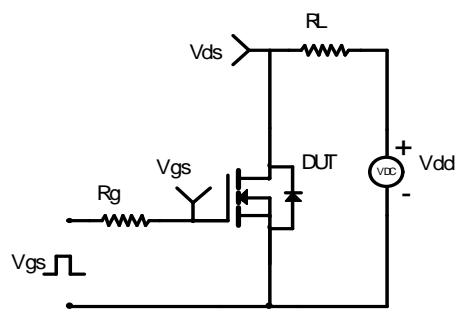


AOT7S60/AOB7S60/AOTF7S60

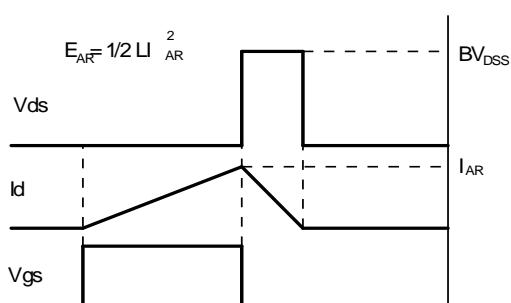
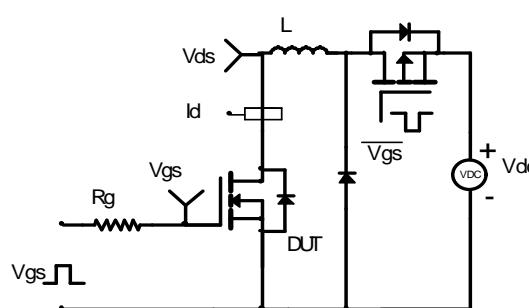
Gate Charge Test Circuit & Waveform



Resistive Switching Test Circuit & Waveforms



Unclamped Inductive Switching (UIS) Test Circuit & Waveforms



Diode Recovery Test Circuit & Waveforms

